SunLED
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Part Number: **LM2BG01W**

10mm SOLID STATE LAMP

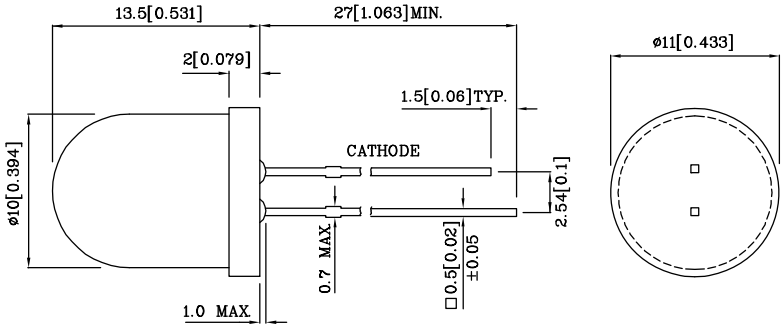
PRELIMINARY SPEC

Features

- ●10mm DIAMETER BIG LAMP.
- ●I.C. COMPATIBLE.
- ●RELIABLE AND RUGGED.
- ●LONG LIFE - SOLID STATE RELIABILITY.
- ●RoHS COMPLIANT.



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

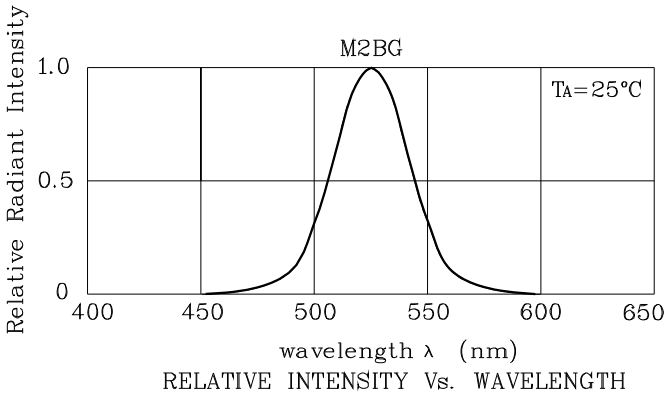


Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25(0.01") unless otherwise noted.
3.Specifications are subject to change without notice.

Absolute Maximum Ratings (T_A=25°C)		**M2BG (InGaN)**	**Unit**
Reverse Voltage	V_R	5	V
Forward Current	I_F	30	mA
Forward Current (peak) 1/10 Duty Cycle 0.1ms Pulse Width	i_{FS}	100	mA
Power Dissipation	P_T	111	mW
Operating Temperature	T_A	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	
Electrostatic Discharge Threshold (HBM)		1000	V
Lead Solder Temperature [2mm Below Package Base]		260°C For 3 Seconds	
Lead Solder Temperature [5mm Below Package Base]		260°C For 5 Seconds	

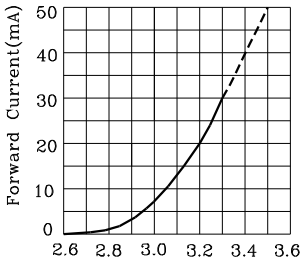
Operating Characteristics (T_A=25°C)		**M2BG (InGaN)**	**Unit**
Forward Voltage (Typ.) (I_F=20mA)	V_F	3.2	V
Forward Voltage (Max.) (I_F=20mA)	V_F	3.7	V
Reverse Current (Max.) (V_R=5V)	I_R	10	uA
Wavelength Of Peak Emission (Typ.) (I_F=20mA)	λ P	525	nm
Wavelength Of Dominant Emission (Typ.) (I_F=20mA)	λ D	535	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I_F=20mA)	Δλ	39	nm
Capacitance (Typ.) (V_F=0V, f=1MHz)	C	65	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.		
LM2BG01W	Green	InGaN	Water Clear	8000	17990	525	15°

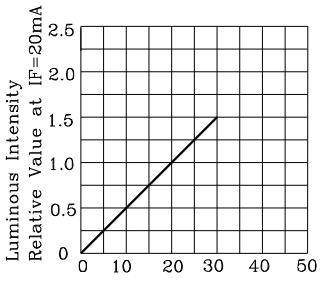


RELATIVE INTENSITY Vs. WAVELENGTH

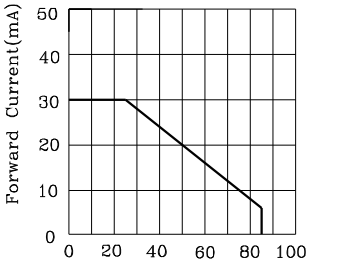
❖ **M2BG**



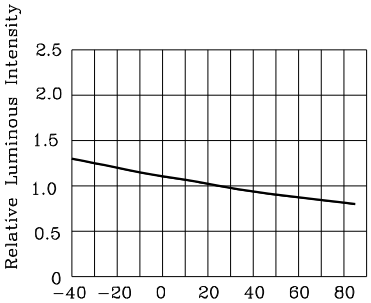
FORWARD CURRENT Vs.
FORWARD VOLTAGE



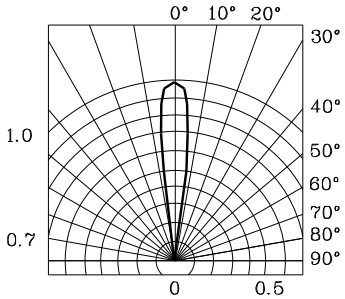
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

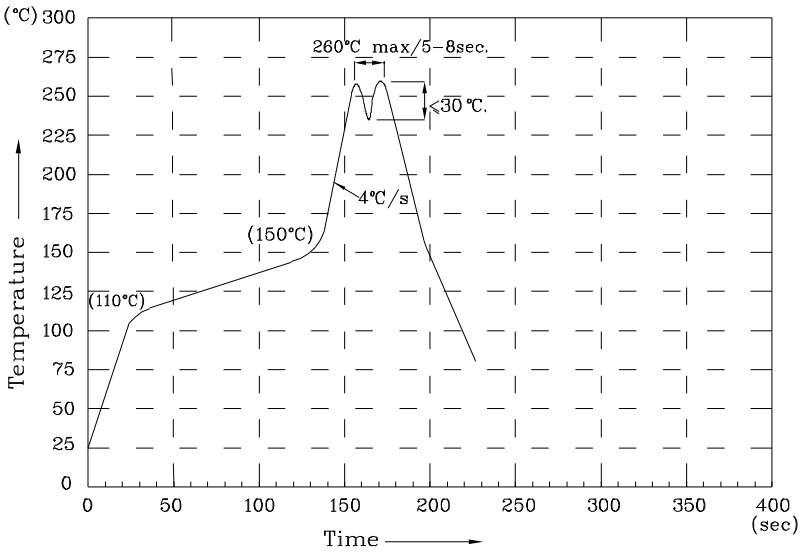


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

1. Recommend the wave temperature 245℃~260℃. The maximum soldering temperature should be less than 260℃.
2. Do not apply stress on epoxy resins when temperature is over 85 degree℃.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. No more than once.

Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous intensity / luminous flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS LM2BG01W

